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Docket No. 420099-654 LSI Logic No. P-2880/1D

FAU. 11.0

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application Of:

MIKE LIANG

Serial Number: 08/909,312

Filing Date: August 14, 1997

Entitled: METHOD FOR DISTRIBUTING

CONNECTION PADS ON A SEMICONDUCTOR DIE

(AS AMENDED)

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APR 0 6 1998

GROUP 000

Group Art Unit: 1104

Examiner:

Honorable Commissioner of Patents and Trademarks Washington, D.C. 20231

SECOND SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Sir:

Submitted herewith are one sheet of Form PTO-1449 and one copy of each of the patent documents listed therein for the above-captioned divisional application.

It is respectfully requested that the Examiner make his consideration of these documents formally of record with his initial action.

PATENT Docket No. 420099-654 LSI Logic No. P-2880/1D

If any fees are due with this Second Supplemental Information Disclosure Statement, the Commissioner is authorized to charge them to Deposit Account Number 16-2230.

Douglas, N. Larson

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Respectfully submitted,

Dated: February 12, 1998

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